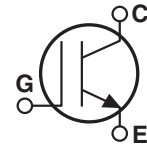


## Thunderbolt IGBT®

The Thunderbolt IGBT® is a new generation of high voltage power IGBTs. Using Non-Punch Through Technology, the Thunderbolt IGBT® offers superior ruggedness and ultrafast switching speed.

- Low Forward Voltage Drop
- Low Tail Current
- RBSOA and SCSOA Rated
- High Freq. Switching to 80KHz
- Ultra Low Leakage Current



### MAXIMUM RATINGS

All Ratings:  $T_C = 25^\circ\text{C}$  unless otherwise specified.

Symbol	Parameter	APT100GT60JR	UNIT
$V_{CES}$	Collector-Emitter Voltage	600	Volts
$V_{GE}$	Gate-Emitter Voltage	$\pm 30$	
$I_{C1}$	Continuous Collector Current @ $T_C = 25^\circ\text{C}$	148	Amps
$I_{C2}$	Continuous Collector Current @ $T_C = 100^\circ\text{C}$	80	
$I_{CM}$	Pulsed Collector Current <sup>①</sup>	300	
SSOA	Switching Safe Operating Area @ $T_J = 150^\circ\text{C}$	300A @ 600V	
$P_D$	Total Power Dissipation	500	Watts
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to 150	$^\circ\text{C}$
$T_L$	Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec.	300	

### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage ( $V_{GE} = 0V, I_C = 4mA$ )	600			Volts
$V_{GE(TH)}$	Gate Threshold Voltage ( $V_{CE} = V_{GE}, I_C = 1.5mA, T_J = 25^\circ\text{C}$ )	3	4	5	
$V_{CE(ON)}$	Collector-Emitter On Voltage ( $V_{GE} = 15V, I_C = 100A, T_J = 25^\circ\text{C}$ )	1.7	2.1	2.5	
	Collector-Emitter On Voltage ( $V_{GE} = 15V, I_C = 100A, T_J = 125^\circ\text{C}$ )		2.5		
$I_{CES}$	Collector Cut-off Current ( $V_{CE} = 600V, V_{GE} = 0V, T_J = 25^\circ\text{C}$ ) <sup>②</sup>			25	$\mu\text{A}$
	Collector Cut-off Current ( $V_{CE} = 600V, V_{GE} = 0V, T_J = 125^\circ\text{C}$ ) <sup>②</sup>			TBD	
$I_{GES}$	Gate-Emitter Leakage Current ( $V_{GE} = \pm 30V$ )			300	nA



CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

**DYNAMIC CHARACTERISTICS**

**APT100GT60JR**

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C <sub>ies</sub>	Input Capacitance	<b>Capacitance</b> V <sub>GE</sub> = 0V, V <sub>CE</sub> = 25V f = 1 MHz		5430		pF
C <sub>oes</sub>	Output Capacitance			508		
C <sub>res</sub>	Reverse Transfer Capacitance			312		
V <sub>GEP</sub>	Gate-to-Emitter Plateau Voltage	Gate Charge V <sub>GE</sub> = 15V V <sub>CE</sub> = 300V I <sub>C</sub> = 100A		8.0		V
Q <sub>g</sub>	Total Gate Charge <sup>③</sup>			460		
Q <sub>ge</sub>	Gate-Emitter Charge			40		
Q <sub>gc</sub>	Gate-Collector ("Miller") Charge			210		
SSOA	Switching Safe Operating Area	T <sub>J</sub> = 150°C, R <sub>G</sub> = 4.3Ω, V <sub>GE</sub> = 15V, L = 100μH, V <sub>CE</sub> = 600V	300			A
t <sub>d(on)</sub>	Turn-on Delay Time	<b>Inductive Switching (25°C)</b> V <sub>CC</sub> = 400V V <sub>GE</sub> = 15V I <sub>C</sub> = 100A R <sub>G</sub> = 4.3Ω T <sub>J</sub> = +25°C		40		ns
t <sub>r</sub>	Current Rise Time			75		
t <sub>d(off)</sub>	Turn-off Delay Time			320		
t <sub>f</sub>	Current Fall Time			100		
E <sub>on1</sub>	Turn-on Switching Energy <sup>④</sup>			3250		μJ
E <sub>on2</sub>	Turn-on Switching Energy (Diode) <sup>⑤</sup>			3525		
E <sub>off</sub>	Turn-off Switching Energy <sup>⑥</sup>			3125		
t <sub>d(on)</sub>	Turn-on Delay Time	<b>Inductive Switching (125°C)</b> V <sub>CC</sub> = 400V V <sub>GE</sub> = 15V I <sub>C</sub> = 100A R <sub>G</sub> = 4.3Ω T <sub>J</sub> = +125°C		40		ns
t <sub>r</sub>	Current Rise Time			75		
t <sub>d(off)</sub>	Turn-off Delay Time			350		
t <sub>f</sub>	Current Fall Time			100		
E <sub>on1</sub>	Turn-on Switching Energy <sup>④</sup>			3275		μJ
E <sub>on2</sub>	Turn-on Switching Energy (Diode) <sup>⑤</sup>			4650		
E <sub>off</sub>	Turn-off Switching Energy <sup>⑥</sup>			3750		

**THERMAL AND MECHANICAL CHARACTERISTICS**

Symbol	Characteristic	MIN	TYP	MAX	UNIT
R <sub>θJC</sub>	Junction to Case ( <b>IGBT</b> )			.25	°C/W
R <sub>θJC</sub>	Junction to Case ( <b>DIODE</b> )			N/A	
W <sub>T</sub>	Package Weight		29.2		gm
V <sub>Isolation</sub>	RMS Voltage (50-60Hz Sinusoidal Wavefomr Ffrom Terminals to Mounting Base for 1 Min.)	2500			Volts

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② For Combi devices, I<sub>ces</sub> includes both IGBT and FRED leakages
- ③ See MIL-STD-750 Method 3471.
- ④ E<sub>on1</sub> is the clamped inductive turn-on energy of the IGBT only, without the effect of a commutating diode reverse recovery current adding to the IGBT turn-on loss. Tested in inductive switching test circuit shown in figure 21, but with a Silicon Carbide diode.
- ⑤ E<sub>on2</sub> is the clamped inductive turn-on energy that includes a commutating diode reverse recovery current in the IGBT turn-on switching loss. (See Figures 21, 22.)
- ⑥ E<sub>off</sub> is the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1. (See Figures 21, 23.)

Microsemi Reserves the right to change, without notice, the specifications and information contained herein.

# TYPICAL PERFORMANCE CURVES

APT100GT60JR

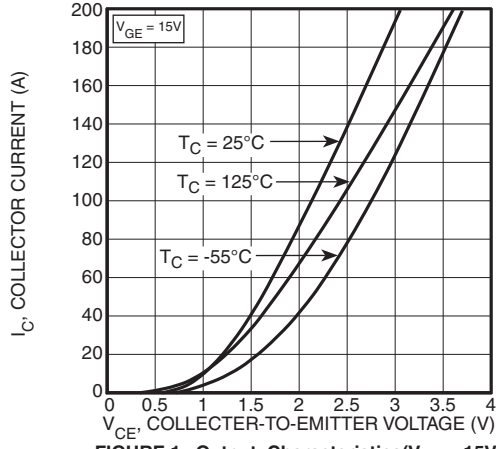


FIGURE 1, Output Characteristics ( $V_{GE} = 15V$ )

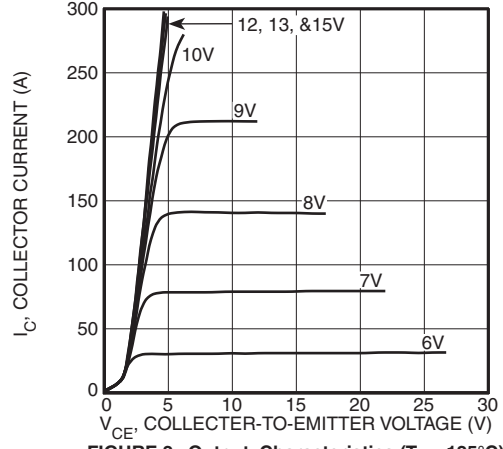


FIGURE 2, Output Characteristics ( $T_J = 125^\circ C$ )

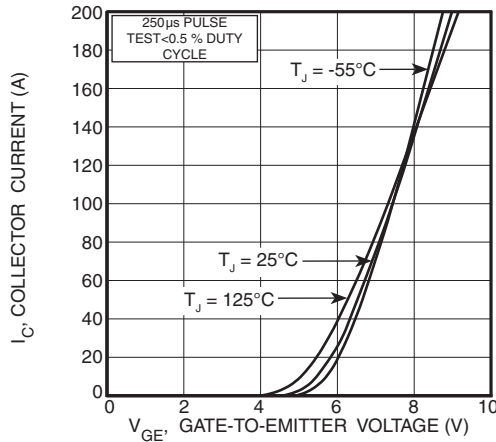


FIGURE 3, Transfer Characteristics

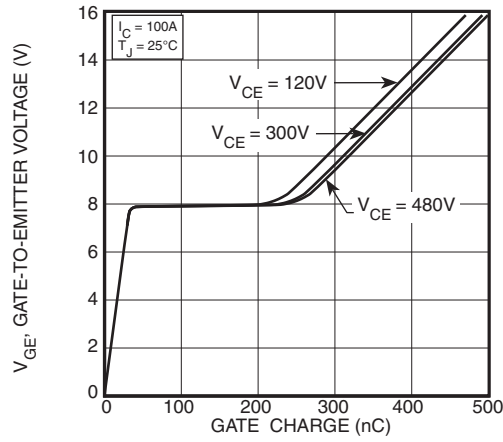


FIGURE 4, Gate Charge

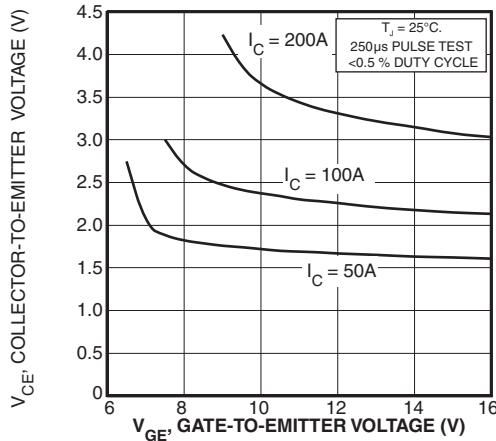


FIGURE 5, On State Voltage vs Gate-to-Emitter Voltage

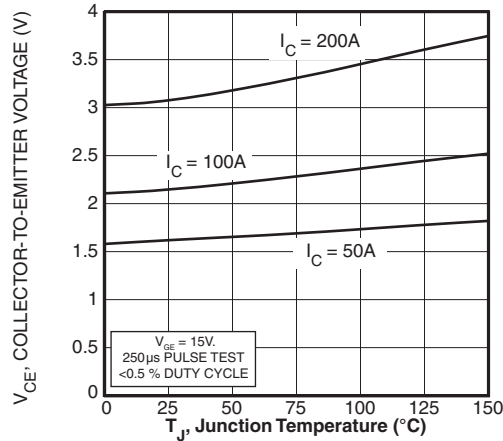


FIGURE 6, On State Voltage vs Junction Temperature

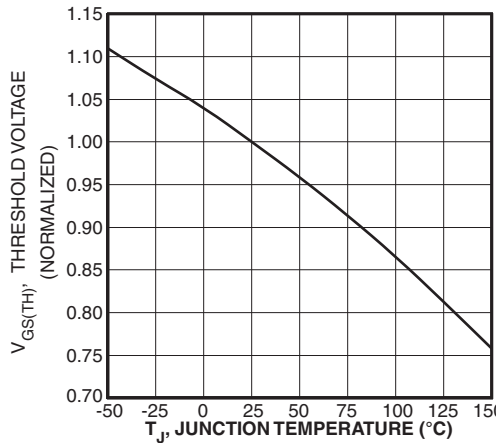


FIGURE 7, Threshold Voltage vs. Junction Temperature

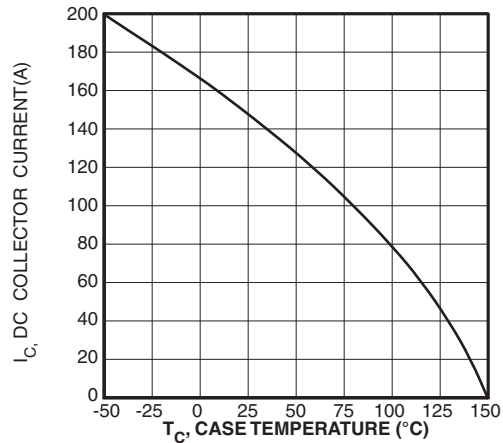


FIGURE 8, DC Collector Current vs Case Temperature

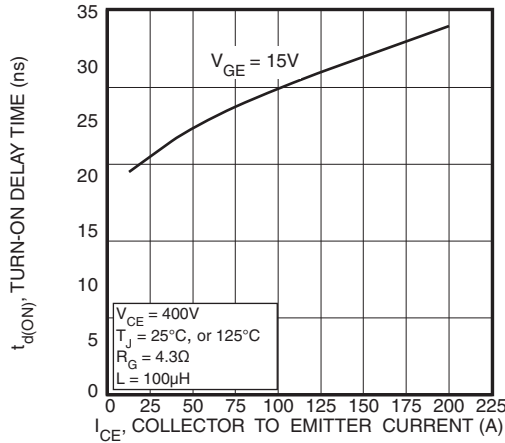


FIGURE 9, Turn-On Delay Time vs Collector Current

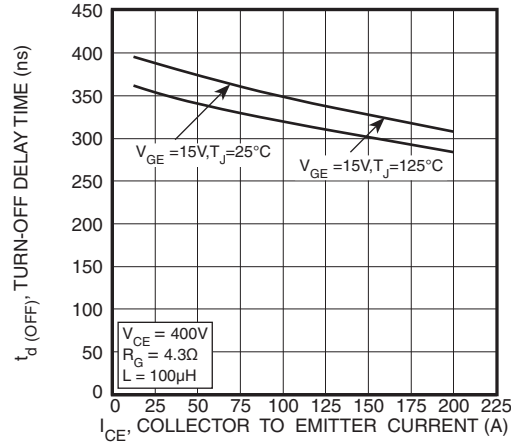


FIGURE 10, Turn-Off Delay Time vs Collector Current

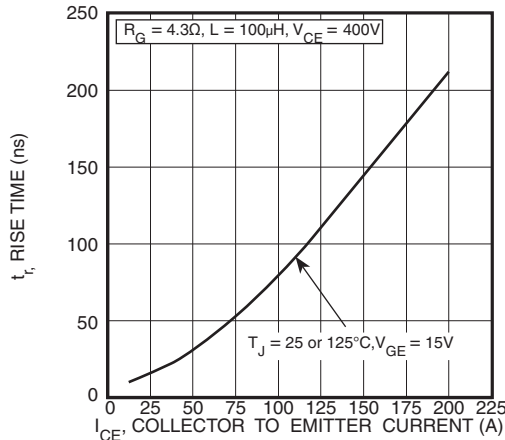


FIGURE 11, Current Rise Time vs Collector Current

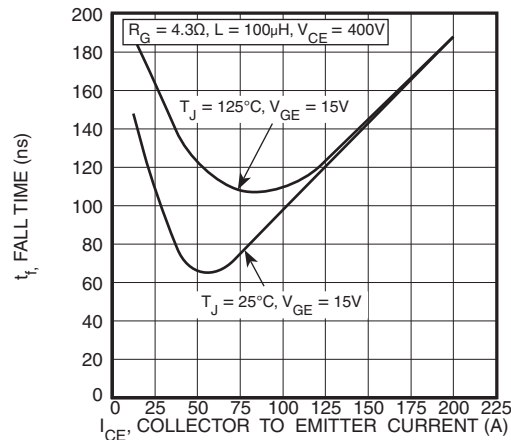


FIGURE 12, Current Fall Time vs Collector Current

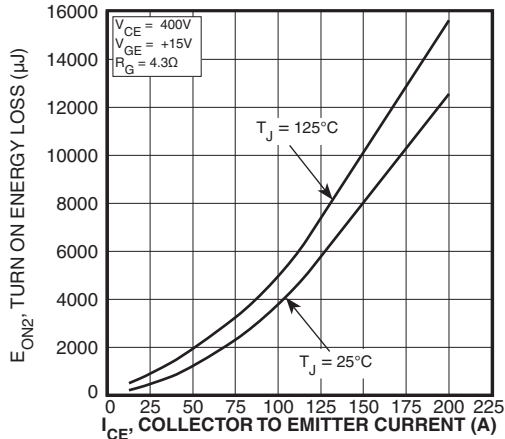


FIGURE 13, Turn-On Energy Loss vs Collector Current

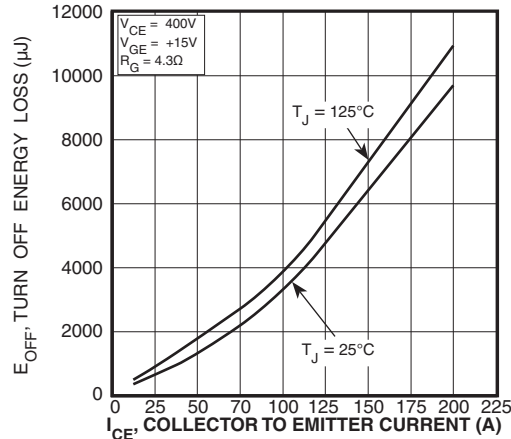


FIGURE 14, Turn Off Energy Loss vs Collector Current

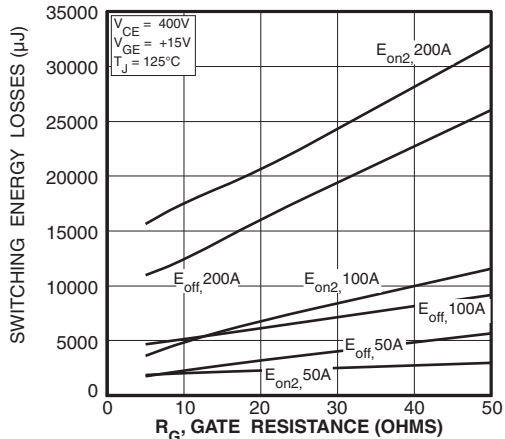


FIGURE 15, Switching Energy Losses vs. Gate Resistance

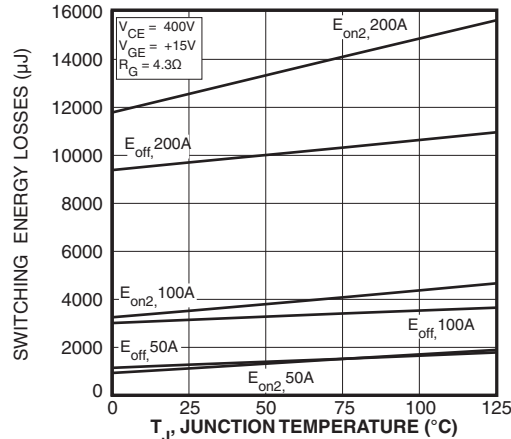


FIGURE 16, Switching Energy Losses vs Junction Temperature

**TYPICAL PERFORMANCE CURVES**

**APT100GT60JR**

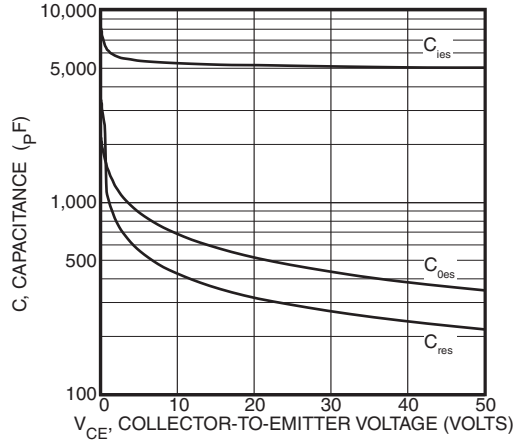


Figure 17, Capacitance vs Collector-To-Emitter Voltage

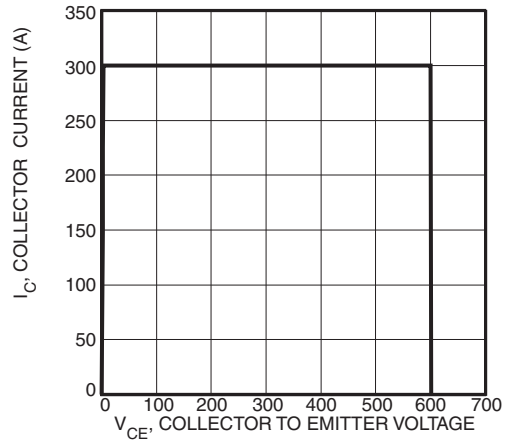


Figure 18, Minimum Switching Safe Operating Area

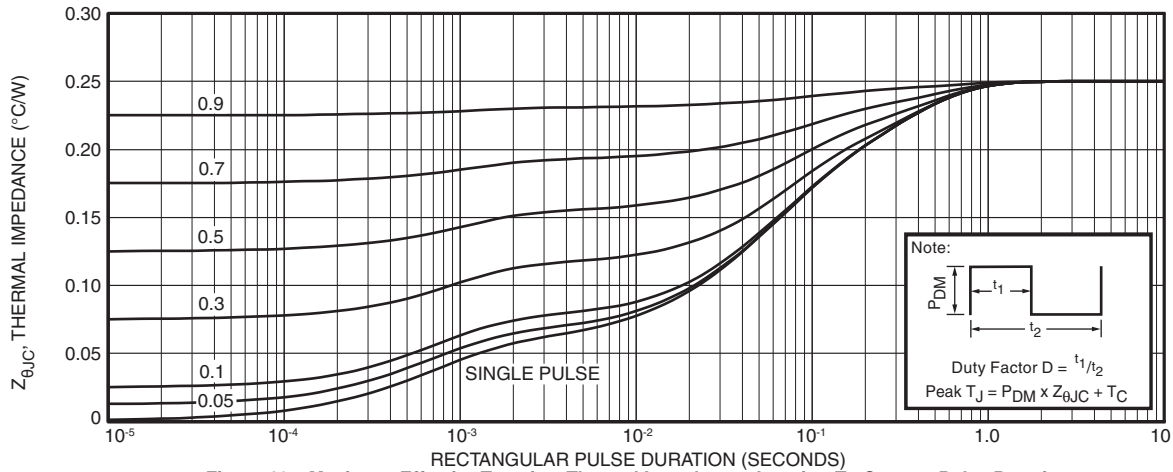


Figure 19a, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration

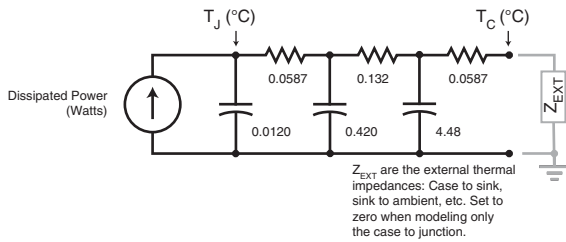


FIGURE 19b, TRANSIENT THERMAL IMPEDANCE MODEL

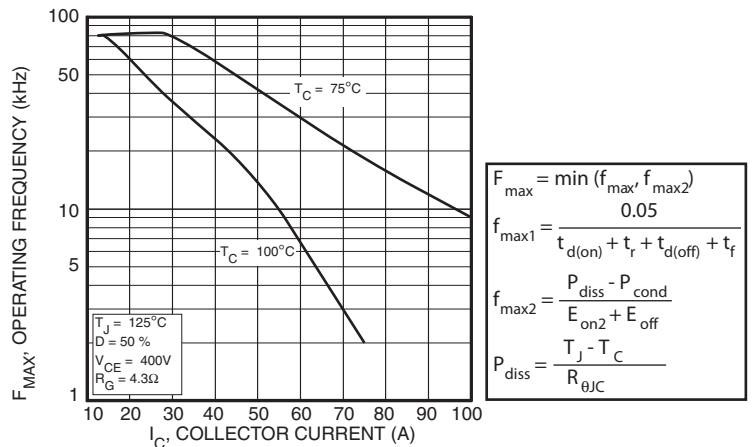


Figure 20, Operating Frequency vs Collector Current

$$F_{max} = \min(f_{max1}, f_{max2})$$

$$f_{max1} = \frac{0.05}{t_{d(on)} + t_r + t_{d(off)} + t_f}$$

$$f_{max2} = \frac{P_{diss} - P_{cond}}{E_{on2} + E_{off}}$$

$$P_{diss} = \frac{T_J - T_C}{R_{\theta JC}}$$

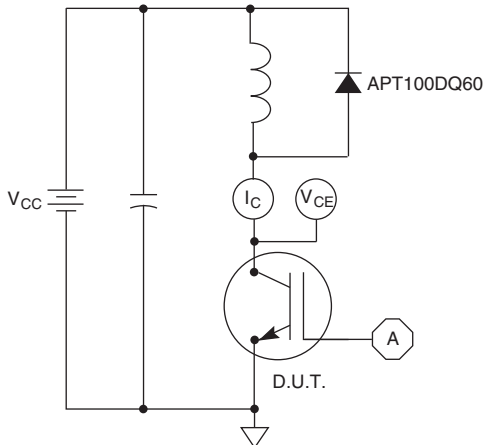


Figure 21, Inductive Switching Test Circuit

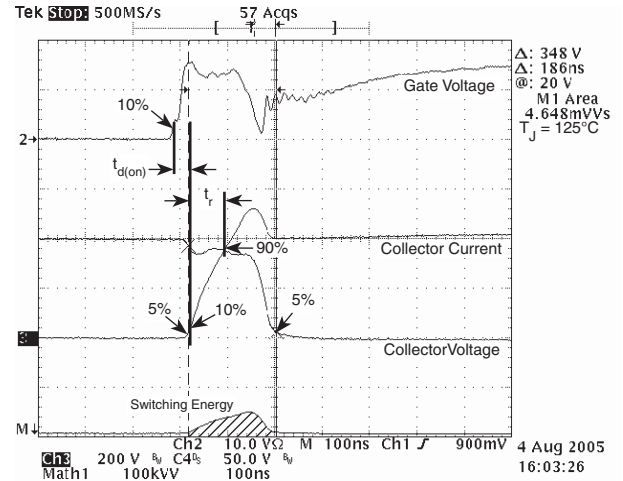


Figure 22, Turn-on Switching Waveforms and Definitions

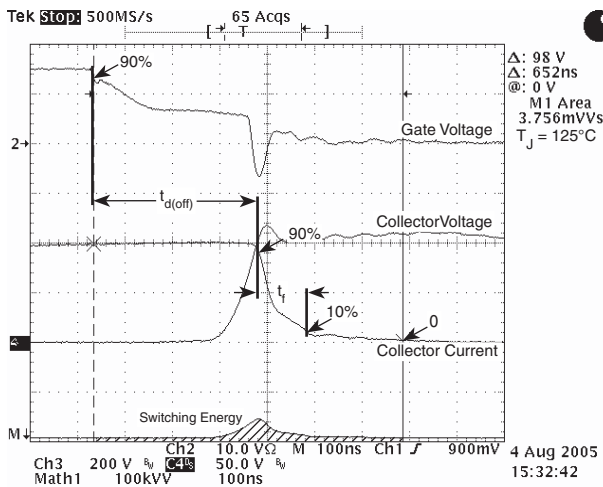
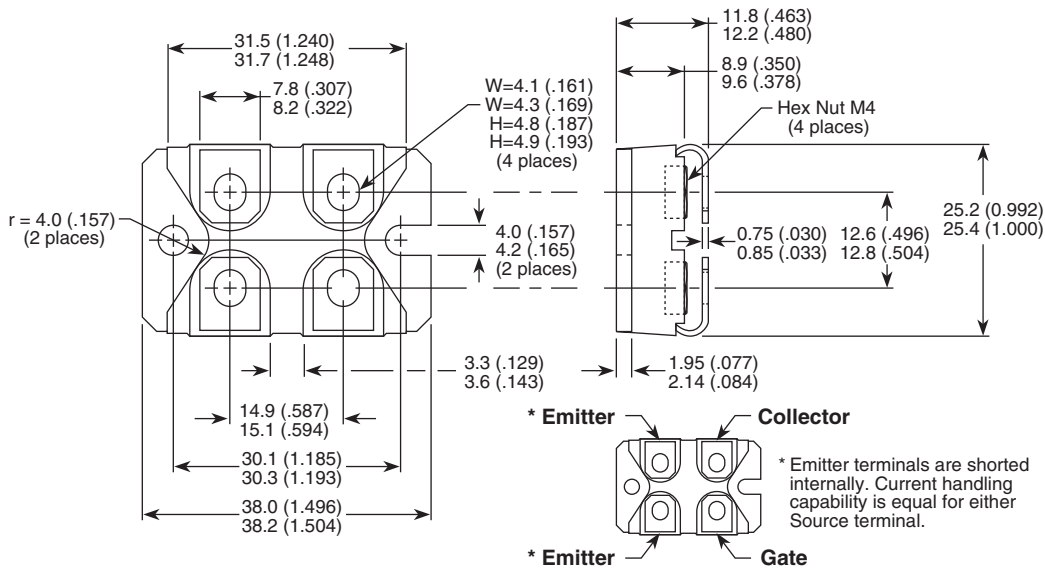


Figure 23, Turn-off Switching Waveforms and Definitions

SOT-227 (ISOTOP®) Package Outline



Dimensions in Millimeters and (Inches)

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